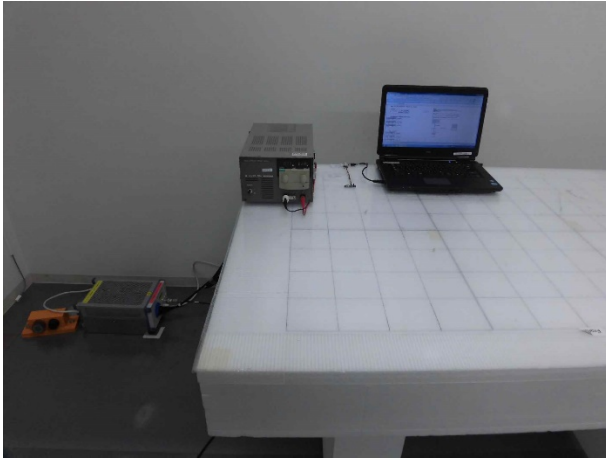


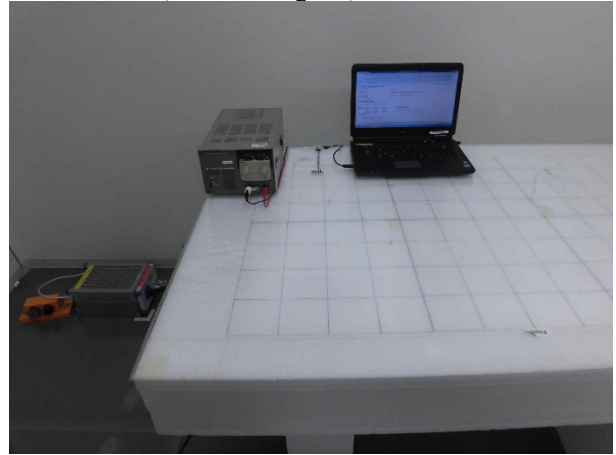
### **APPENDIX 3: Photographs of test setup**

#### **Conducted Emission**

BT LE

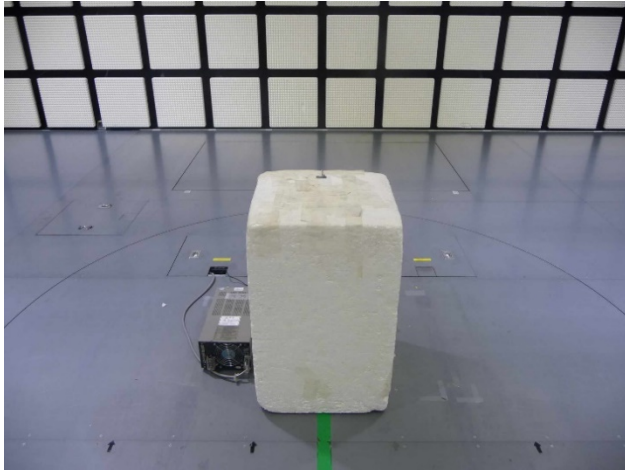


ANT, Nordic Original, IEEE802.15.4

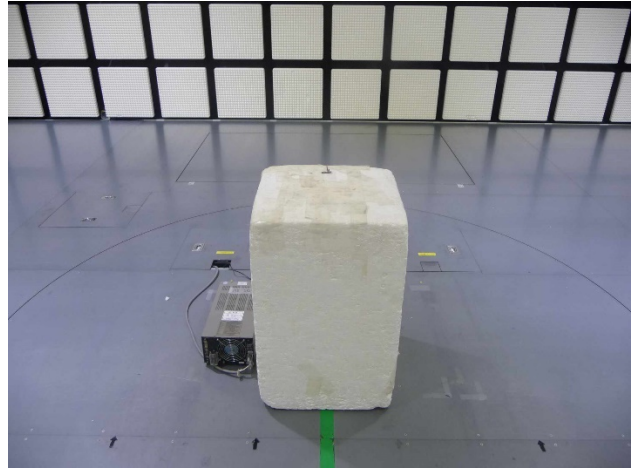


## **Radiated Spurious Emission**

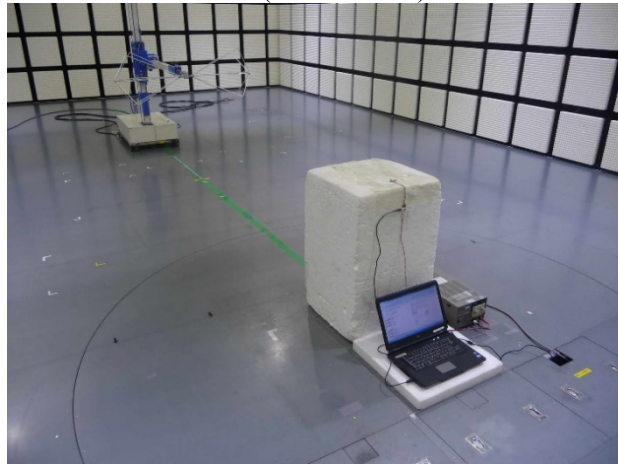
BT LE  
Front



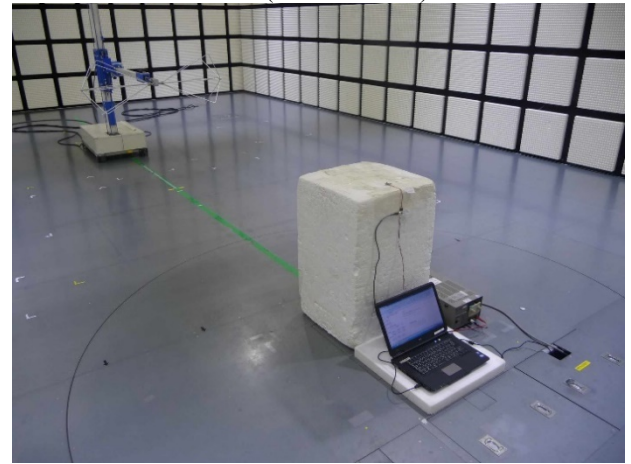
ANT, Nordic Original, IEEE802.15.4  
Front



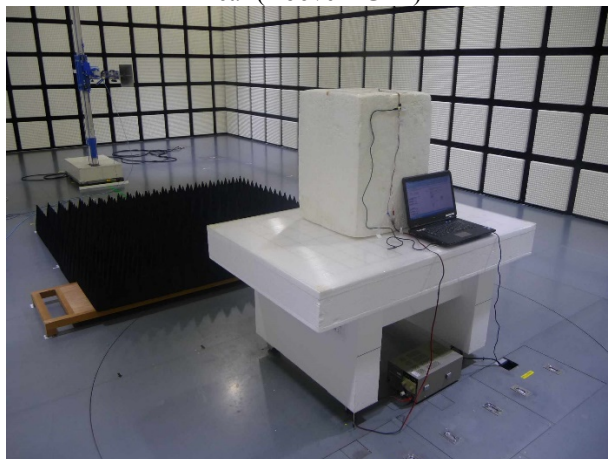
Rear (Below 1 GHz)



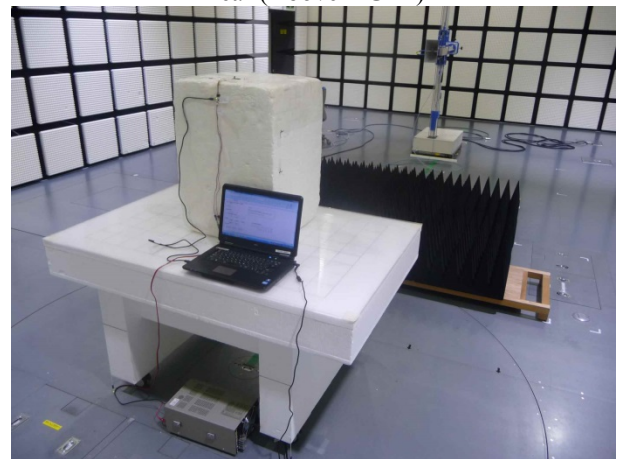
Rear (Below 1 GHz)



Rear (Above 1 GHz)

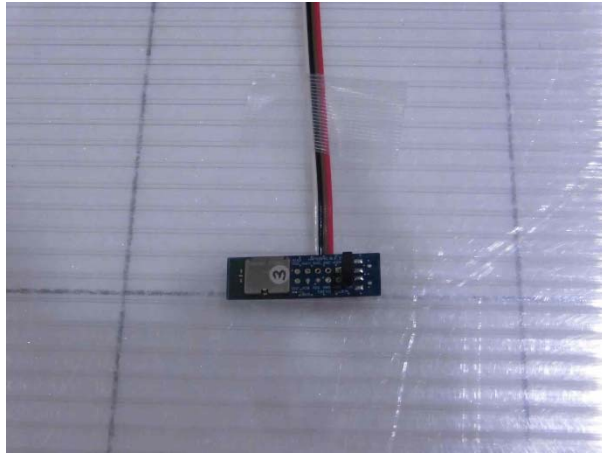


Rear (Above 1 GHz)

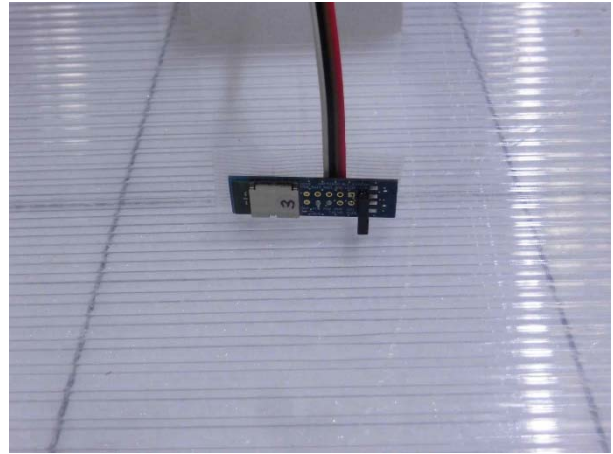


### Worst Case Position

**X-axis**



**Y-axis**



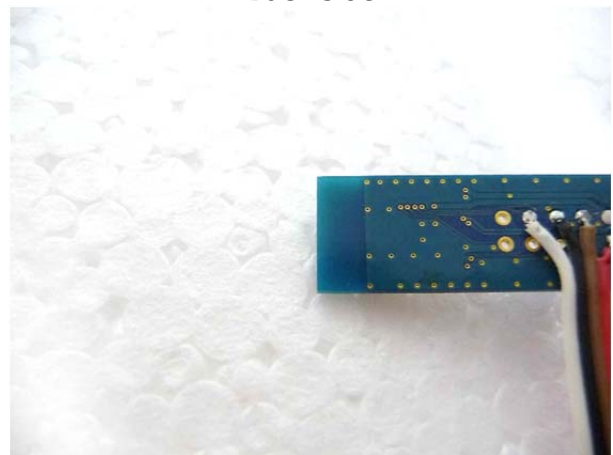
**Z-axis**



**Upper side**



**Back side**



\*Use the motherboard with no metal plate, therefore this motherboard does not affect the module test condition.

### **End of Report**

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